

# Organic Field-Effect Transistor Using Oligoselenophene as an Active Layer

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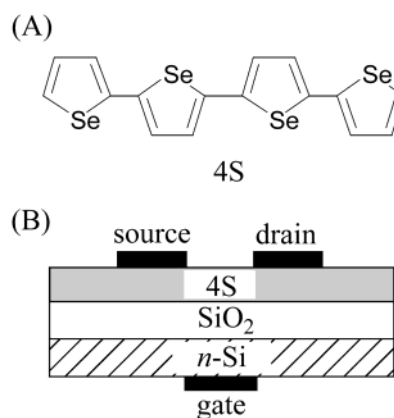
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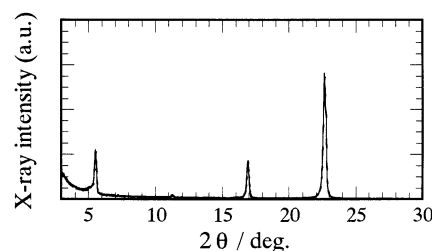
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Thiophene oligomers and polymers are promising compounds applicable to organic field-effect transistors<sup>1</sup> (OFETs), photodiodes,<sup>2</sup> light-emitting diodes,<sup>3</sup> and their integrated devices.<sup>4</sup> Selenophene is a homologue of the chalcogenophenes and the chemical and physical properties are similar to those of thiophene. To our knowledge, however, there has been no report on organic devices made with oligo- or polyselenophenes. This may be ascribable to the poor electrical properties of the polyselenophenes reported in early studies of the system. For example, the conductivities of doped polyselenophene films<sup>5</sup> are in the range of  $10^{-4}$ – $10^{-2}$  S cm<sup>-1</sup>, which are fairly small compared with those ( $10$ – $100$  S cm<sup>-1</sup>) of doped polythiophenes.<sup>6</sup> Recently, we have synthesized structurally well-characterized oligoselenophenes and found that the iodine-doped oligoselenophenes exhibit the conductivities of  $10^{-2}$  S cm<sup>-1</sup>, which are comparable with those of the analogous doped oligothiophenes.<sup>7</sup> This result encourages us in the studies of electronic devices based on organic functionality materials. The present work is the first report of an OFET made with oligoselenophene, showing good FET behavior.

2,2':5',2'':5'',2'''-Quaterselenophene (4S) was synthesized by the Stille coupling reaction between dibromo-



**Figure 1.** (A) The chemical structure of 4S and (B) the device structure of the OFET.



**Figure 2.** X-ray diffraction pattern of the 4S film (50 nm) deposited on Si/SiO<sub>2</sub> at  $T_s = 20$  °C.

biselenophene and 2-fold of 2-tributylstanyl selenophene<sup>7</sup> and purified twice by sublimation prior to use.<sup>8</sup> OFETs were fabricated on heavily doped  $n^+$ -Si (100) wafers with a 220-nm thermally grown SiO<sub>2</sub> (Figure 1). The 4S film (50-nm thick) was vacuum-deposited onto the Si/SiO<sub>2</sub> substrate, and successively Au films (100 nm) as drain and source electrodes were deposited on the organic layer through a shadow mask. For a typical device, the drain-source channel length and width are 50  $\mu$ m and 2 mm, respectively. Characteristics of a drain current ( $I_d$ ) versus drain voltage ( $V_d$ ) of the OFET devices were measured under vacuum with an ADVANTEST R6245 power supply. The field-effect mobilities were calculated in the saturation regime of the  $I_d$  as shown in a previous paper.<sup>9</sup> X-ray diffractions (Cu,  $\lambda_{K\alpha} = 1.541$  Å) of the organic thin films on Si/SiO<sub>2</sub> substrate were measured with a Maxscience M18XHF diffractometer. AFM images of the organic thin films were obtained by using a Shimadzu SPM-9500 microscope. All the measurements were conducted at room temperature (RT).

The sublimed film of 4S is orange and shiny. X-ray diffraction of the 4S film on Si/SiO<sub>2</sub> shows a series of the peaks, indicating the order of the molecular repeat with 15.7 Å (Figure 2). This value was independent of the substrate temperature ( $T_s$ ) and consistent with the  $b$ -axis of the single-crystal unit cell ( $a = 7.94$  Å,  $b = 15.93$  Å,  $c = 6.07$  Å), corresponding to the direction of

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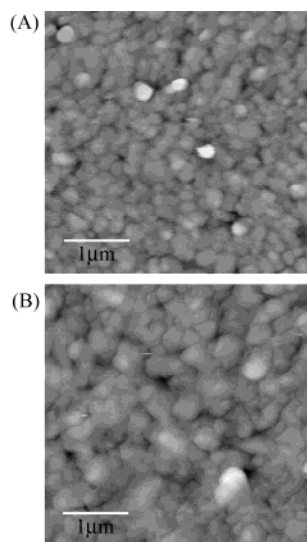
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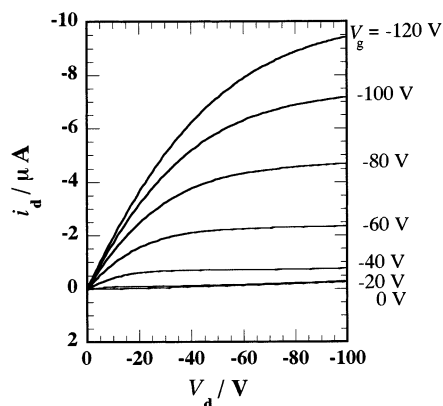
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(8) Toxicities of the oligoselenophene compounds are not well-known. The synthesis must be carefully performed in an efficient hood. Disposable vinyl or latex gloves and chemical-resistant safety goggles should be worn.

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**Figure 3.** AFM images of the 4S films (50 nm) deposited on Si/SiO<sub>2</sub> at (A)  $T_s = 20\text{ }^{\circ}\text{C}$  and (B)  $T_s = 60\text{ }^{\circ}\text{C}$ .



**Figure 4.**  $i_d$  vs  $V_d$  curves at different gate biases for the OFET device using the 4S film ( $T_s = 60\text{ }^{\circ}\text{C}$ ) as an active layer.

the molecular long axis.<sup>10</sup> In other words, the molecule arrangement is essentially normal to the substrate. It is well-known that this type of orientation is particularly useful in achieving high carrier mobility because the direction of  $\pi$ - $\pi$  stacking is in the plane of the current-flow direction.

In general, the field-effect mobility of an organic semiconductor depends on the grain size of the crystal as well as the orientation of the molecules. Figure 3 shows AFM images of the 4S films deposited on Si/SiO<sub>2</sub> at different substrate temperatures. The grain size is  $0.04\text{--}0.1\text{ }\mu\text{m}^2$  at  $T_s = 20\text{ }^{\circ}\text{C}$  and increases to  $0.1\text{--}0.3\text{ }\mu\text{m}^2$  at  $T_s = 60\text{ }^{\circ}\text{C}$ . However, further  $T_s$  elevation did not affect the grain size anymore.

Figure 4 represents a typical plot of the  $i_d$  versus  $V_d$  at various gate voltages for the OFET based on 4S. The channel conductance increases as the  $V_g$  becomes more

**Table 1.** Field-Effect Mobilities of the 4S and 4T Films Prepared at Different Substrate Temperatures

compound	$T_s$ ( $^{\circ}\text{C}$ )	mobility ( $\text{cm}^2\text{ V}^{-1}\text{ s}^{-1}$ )	grain size ( $\mu\text{m}^2$ )
4S	20	$1.3 \times 10^{-3}$	0.04–0.1
4S	60	$3.6 \times 10^{-3}$	0.1–0.3
4S	100	$0.8 \times 10^{-3}$	0.1–0.3
4T	RT	$1\text{--}2.5 \times 10^{-3\text{ }a,b}$	
4T	65	$5\text{--}8 \times 10^{-3\text{ }b}$	$3\text{--}8^b$

<sup>a</sup> Reference 11. <sup>b</sup> Reference 12.

negative, meaning that the 4S film behaves as a *p*-type semiconductor. The field-effect mobilities estimated for the 4S were summarized in Table 1, together with those of quaterthiophene (4T) for comparison. The mobilities depend strongly on the deposition temperature. The mobility of the 4S deposited at  $60\text{ }^{\circ}\text{C}$  was higher than that at  $20\text{ }^{\circ}\text{C}$ . This is attributed to the difference in grain size between the films prepared at  $20$  and  $60\text{ }^{\circ}\text{C}$  (see Figure 3). It is worthy of note that the mobility of the 4S deposited at  $100\text{ }^{\circ}\text{C}$  is small compared with that at  $60\text{ }^{\circ}\text{C}$ . Similar trends have been reported for oligothiophenes and the derivatives,<sup>13</sup> but the reason for the decrease of mobilities has not been explained clearly yet. Thus, the largest mobility of  $3.6 \times 10^{-3}\text{ cm}^2\text{ V}^{-1}\text{ s}^{-1}$  was obtained for the 4S film deposited at  $T_s = 60\text{ }^{\circ}\text{C}$ . It is noted that the mobilities of the 4S film deposited at  $60\text{ }^{\circ}\text{C}$  and 4T film at  $65\text{ }^{\circ}\text{C}$  are almost the same, although the grain sizes are different.

In summary, the OFET using the oligoselenophene as an active layer has been first successfully fabricated. The 4S OFET shows *p*-channel characteristics. The best mobility of  $3.6 \times 10^{-3}\text{ cm}^2\text{ V}^{-1}\text{ s}^{-1}$  was obtained for the 4S film prepared at a substrate temperature of  $60\text{ }^{\circ}\text{C}$ , which is comparable with that for the 4T films deposited at  $65\text{ }^{\circ}\text{C}$ . Oligoselenophenes modified with more selenophene rings or alkyl chains are expected to yield higher mobilities. Further studies are in progress to prove this hypothesis.

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